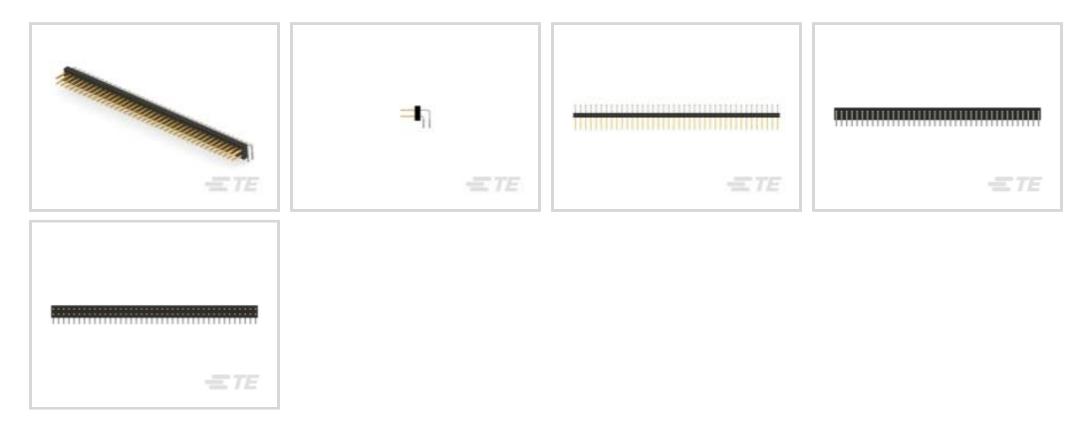
9-103326-0 - ACTIVE

AMPMODU | AMPMODU Headers

TE Internal #: 9-103326-0 PCB Mount Header, Right Angle, Board-to-Board, 80 Position, 2.54 mm [.1 in] Centerline, Breakaway, Gold, Through Hole - Solder, AMPMODU Headers

View on TE.com >

Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Right Angle

Connector System: Board-to-Board

Number of Positions: 80

Number of Rows: 2

Features



Product Type Features

PCB Connector Assembly Type	PCB Mount Header				
Connector System	Board-to-Board				
Header Type	Breakaway				
Sealable	No				
Connector & Contact Terminates To	Printed Circuit Board				
Configuration Features					
Connector Contact Load Condition	Fully Loaded				
PCB Mount Orientation	Right Angle				
Number of Positions	80				
Number of Rows	2				
Body Features					
Primary Product Color	Black				
Contact Features					
Mating Square Post Dimension	.64 mm[.025 in]				
	00/10/2022 11.0				

C For support call+1 800 522 6752

PCB Mount Header, Right Angle, Board-to-Board, 80 Position, 2.54 mm [.1 in] Centerline, Breakaway, Gold, Through Hole - Solder, AMPMODU Headers



	100 – 200 µin	
PCB Contact Termination Area Plating Material Finish	Matte	
Contact Shape & Form	Square	
Contact Underplating Material	Nickel	
PCB Contact Termination Area Plating Material	Tin	
Contact Base Material	Phosphor Bronze	
Contact Mating Area Plating Material	Gold	
Contact Mating Area Plating Material Thickness	.381 μm[15 μin]	
Contact Type	Pin	
Contact Current Rating (Max)	3 A	
Termination Features		
Square Termination Post & Tail Dimension	.64 mm[.025 in]	
Termination Post & Tail Length	3.05 mm[.12 in]	
Termination Method to Printed Circuit Board	Through Hole - Solder	
Mechanical Attachment		
Mating Alignment	Without	
PCB Mount Retention	Without	
PCB Mount Alignment	Without	
Connector Mounting Type	Board Mount	
Housing Features		
Centerline (Pitch)	2.54 mm[.1 in]	
Housing Material	Thermoplastic	
Dimensions		
Row-to-Row Spacing	2.54 mm[.1 in]	
PCB Thickness (Recommended)	1.6 mm[.063 in]	
Usage Conditions		
Housing Temperature Rating	Standard	
Operating Temperature Range	-65 – 105 °C[-85 – 221 °F]	
Operation/Application		
Circuit Application	Signal	
Industry Standards		
Approved Standards	CSA LR7189, UL E28476	
	08/18/2023	

C For support call+1 800 522 6752

PCB Mount Header, Right Angle, Board-to-Board, 80 Position, 2.54 mm [.1 in] Centerline, Breakaway, Gold, Through Hole - Solder, AMPMODU Headers



UL Flammability Rating	UL 94V-0				
Packaging Features					
Packaging Quantity	50				
Packaging Type	Carton				

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Wave solder capable to 265°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts



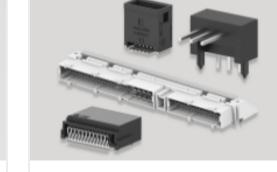
PCB Mount Header, Right Angle, Board-to-Board, 80 Position, 2.54 mm [.1 in] Centerline, Breakaway, Gold, Through Hole - Solder, AMPMODU Headers



Also in the Series AMPMODU Headers





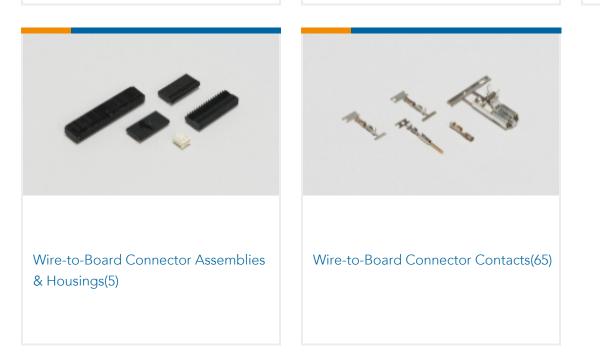




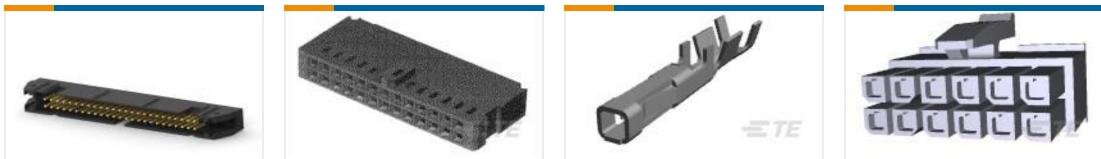
PCB Connector Mounting(1)

PCB Connector Shrouds(1)

PCB Headers & Receptacles(4875) PCB Latches, Locks & Retainers(1)



Customers Also Bought



-ETE			
TE Part #5499786-2 AMP-LATCH UNIVERSAL HEADERS	TE Part #102387-2 14 MODIV HSG COMP DR .100 POL	TE Part #1-794610-2 MICRO MNL RPT CNT,LS PC 30AU L	TE Part #1-794617-2 12POS,MICRO MNL,RCPT HSG
=TE			

TE Part #1-794612-1 PIN CONT 20-24 15 GOLD L/P

TE Part #1-794616-2 FREE HANG DBL ROW HSG 12 POS TE Part #1-87456-0 14 MODIV HSG DR MRKD .100CL TE Part #9-103795-0 80 MODII HDR DRRA B/A .100CL



PCB Mount Header, Right Angle, Board-to-Board, 80 Position, 2.54 mm [.1 in] Centerline, Breakaway, Gold, Through Hole - Solder, AMPMODU Headers



Documents

CAD Files 3D PDF

3D

Customer View Model

ENG_CVM_CVM_9-103326-0_F.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_9-103326-0_F.3d_igs.zip

English

Customer View Model ENG_CVM_CVM_9-103326-0_F.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Environmental Compliance TE Material Declaration

English